

< Silicon RF Power Module >

# RA50H7687M1

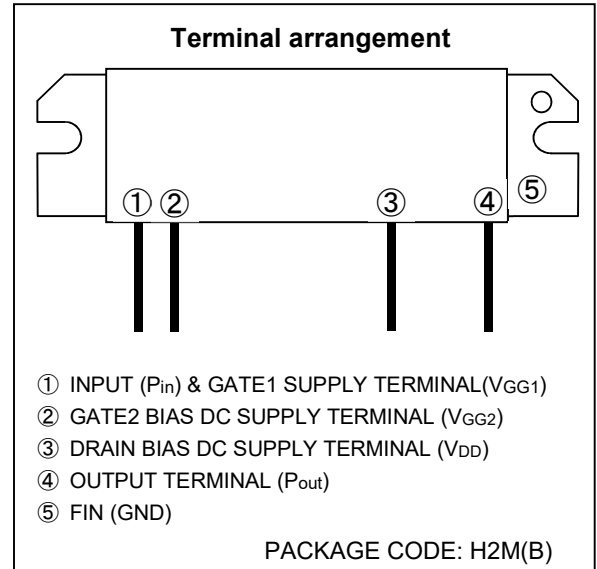
RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For Mobile Radio

## DESCRIPTION

The RA50H7687M1 is a 50W RF MOSFET Amplifier Module for 12.5V mobile radios that operate in the 763 to 870 MHz range.

The battery can be connected directly to the drain of the enhancement-mode MOSFET transistors. Without the gate voltage 1 and the gate voltage 2 ( $V_{GG1}=V_{GG2}=0V$ ), only a small leakage current flows into the drain and the nominal output signal ( $P_{out}=50W$ ) attenuates up to 60 dB. When fixed i.e. 3.6V, is supplied to the gate voltage 1, the output power and the drain current increase as the gate voltage 2 increases. The output power and the drain current increase substantially with the gate voltage 2 around 0V (minimum) under the condition when the gate voltage 1 is kept in 3.6V. The nominal output power becomes available at the state that  $V_{GG2}$  is 4V (typical) and 5V (maximum). At this point,  $V_{GG1}$  has to be kept in 3.6V.

This module is designed for non-linear FM modulation, but may also be used for linear modulation by setting the drain quiescent current with the gate voltages and controlling the output power with the input power.



## FEATURES

- Enhancement-Mode MOSFET Transistors  
( $I_{DD} \approx 0$  @  $V_{DD}=12.5V$ ,  $V_{GG}=0V$ )
- $P_{out} > 50W$ ,  $\eta_T > 40\%$  @  $V_{DD}=12.5V$ ,  $V_{GG1}=3.6V$ ,  $V_{GG2}=5V$ ,  $P_{in}=50mW$
- Broadband Frequency Range: 763-870MHz
- Module Size: 67 x 19.4 x 9.9 mm
- Linear operation is possible by setting the quiescent drain current with the gate voltage and controlling the output power with the input power

## RoHS COMPLIANCE

- RA50H7687M1 is a RoHS compliant products.
- This product include the lead in the Glass of electronic parts and the lead in electronic Ceramic parts.  
However, it is applicable to the following exceptions of RoHS Directions.
  1. Lead in the Glass of a cathode-ray tube, electronic parts, and fluorescent tubes.
  2. Lead in electronic Ceramic parts.

## ORDERING INFORMATION:

ORDER NUMBER	SUPPLY FORM
RA50H7687M1-501	Antistatic tray, 10 modules/tray

**RA50H7687M1**

RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

**MAXIMUM RATINGS** ( $T_{case}=+25^{\circ}\text{C}$ ,  $Z_G=Z_L=50\Omega$ , unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
$V_{DD}$	Drain Voltage	$V_{GG1}=3.6V\pm 7\%$ , $V_{GG2}\leq 5V$	17	V
$V_{GG1}$	Gate Voltage1	$V_{DD}\leq 12.5V$ , $V_{GG2}\leq 5V$ , $P_{in}=50mW$	4.5	V
$V_{GG2}$	Gate Voltage2	$V_{DD}\leq 12.5V$ , $V_{GG1}=3.6V\pm 7\%$ , $P_{in}=50mW$	6	V
$I_{DD}$	Total Current	-	15	A
$P_{in}$	Input Power	$f=763-870MHz$ , $V_{GG1}=3.6V\pm 7\%$ , $V_{GG2}\leq 5V$	100	mW
$P_{out}$	Output Power		65	W
$T_{case(OP)}$	Operation Case Temperature Range		-30 to +100	$^{\circ}\text{C}$
$T_{stg}$	Storage Temperature Range	-	-40 to +110	$^{\circ}\text{C}$

The above parameters are independently guaranteed.

**ELECTRICAL CHARACTERISTICS** ( $T_{case}=+25^{\circ}\text{C}$ ,  $Z_G=Z_L=50\Omega$ , unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
f	Frequency Range	-	763	-	870	MHz
$P_{out1}$	Output Power1	$V_{DD}=12.5V$ , $V_{GG1}=3.6V$ , $V_{GG2}=5V$ , $P_{in}=50mW$	50	-	-	W
$\eta_T$	Total Efficiency		40	-	-	%
$2f_0$	2 <sup>nd</sup> Harmonic		-	-	-40	dBc
$3f_0$	3 <sup>rd</sup> Harmonic		-	-	-35	dBc
$\rho_{in}$	Input VSWR		-	-	3:1	-
$I_{DD}$	Leakage current	$V_{DD}=17V$ , $V_{GG1}=V_{GG2}=0V$ , $P_{in}=0W$	-	-	1	mA
-	Load VSWR Tolerance	$V_{DD}=15.2V$ , $V_{GG1}=3.6V$ , $P_{in}=50mW$ , $P_{out}=50W$ ( $V_{GG2}$ : adj.), Load VSWR=20:1(All Phase)	No degradation or destroy			-
-	Stability	$V_{DD}=10-15.2V$ , $V_{GG1}=3.6V$ , $P_{in}=1-100mW$ , $P_{out}=1.5-55W$ ( $V_{GG2}$ : control, $V_{GG2}\leq 5V$ ) Load VSWR=3:1(All Phase)	No parasitic oscillation more than -65dBc			-
$P_{out2}$	Output Power2 *	$V_{DD}=12.5V$ , $V_{GG1}=3.6V$ , $V_{GG2}=1V$ , $P_{in}=2dBm$	-	-	1.5	W

All parameters, conditions, ratings, and limits are subject to change without notice.

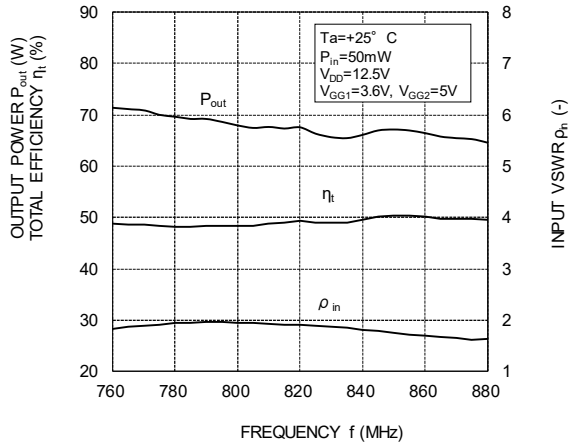
\* This item is tested at the time first lot and design changes.

# RA50H7687M1

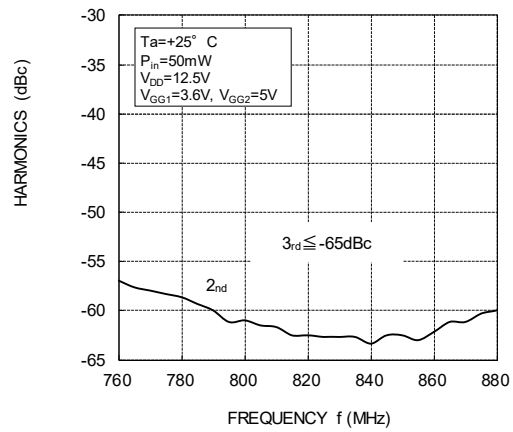
RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

## TYPICAL PERFORMANCE (T<sub>case</sub>=+25°C, Z<sub>G</sub>=Z<sub>L</sub>=50Ω, unless otherwise specified)

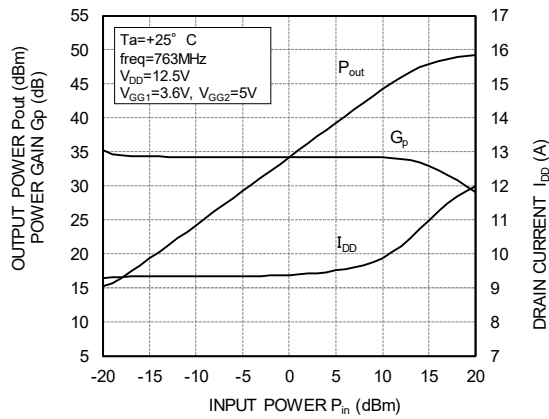
OUTPUT POWER, TOTAL EFFICIENCY, and INPUT VSWR versus FREQUENCY



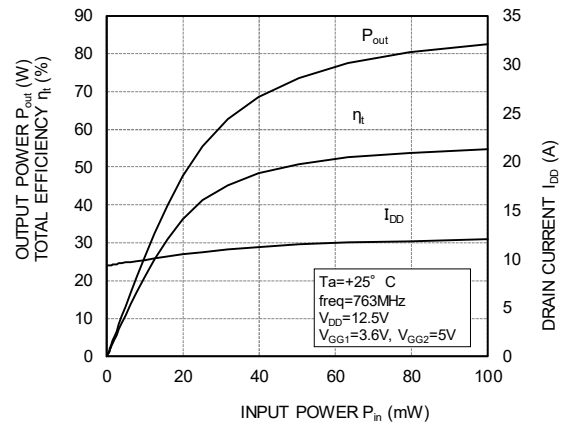
2nd,3rd HARMONICS versus FREQUENCY



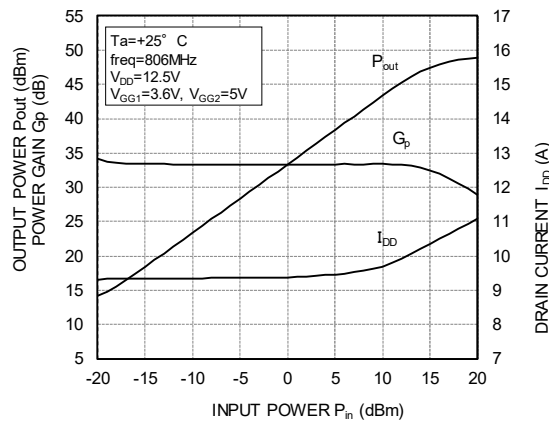
OUTPUT POWER, POWER GAIN and DRAIN CURRENT versus INPUT POWER



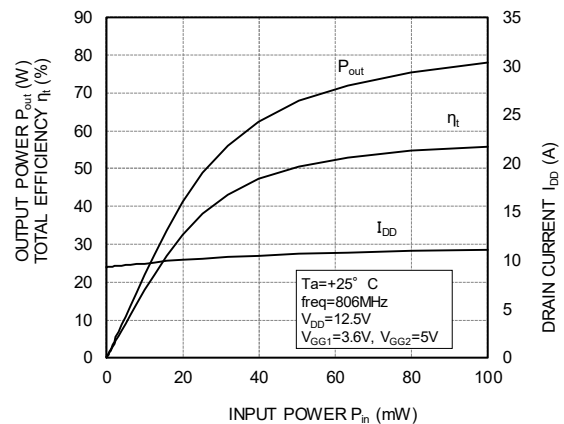
OUTPUT POWER, TOTAL EFFICIENCY and DRAIN CURRENT versus INPUT POWER



OUTPUT POWER, POWER GAIN and DRAIN CURRENT versus INPUT POWER



OUTPUT POWER, TOTAL EFFICIENCY and DRAIN CURRENT versus INPUT POWER

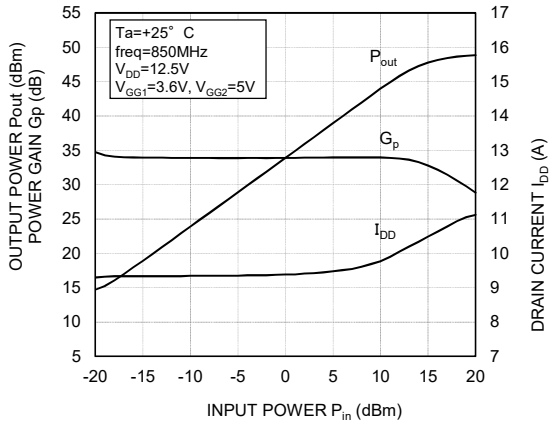


# RA50H7687M1

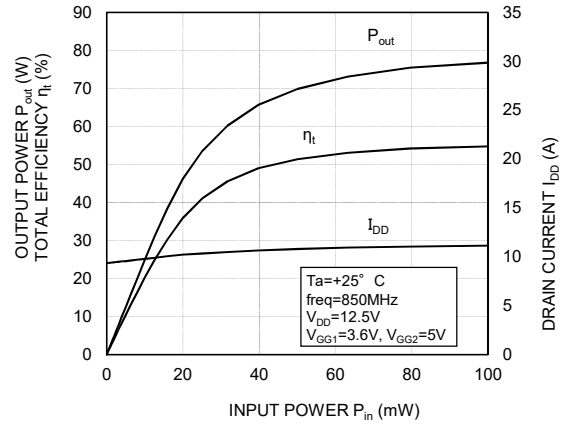
RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

TYPICAL PERFORMANCE (Tcase=+25°C, Zg=Zl=50Ω, unless otherwise specified)

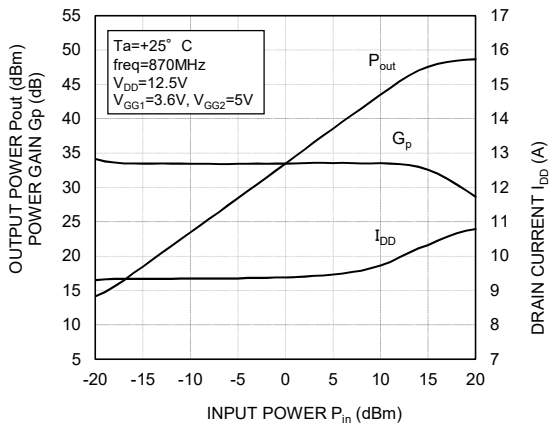
OUTPUT POWER, POWER GAIN and DRAIN CURRENT versus INPUT POWER



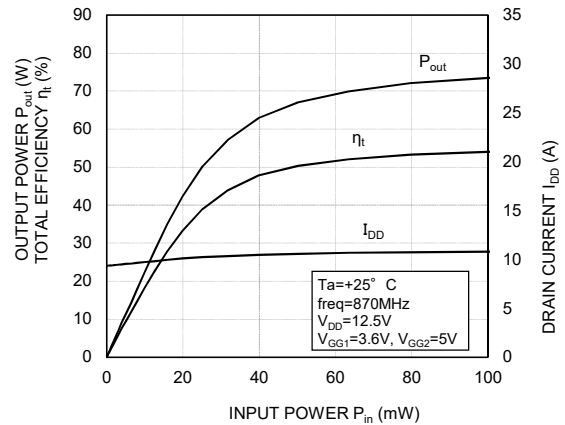
OUTPUT POWER, TOTAL EFFICIENCY and DRAIN CURRENT versus INPUT POWER



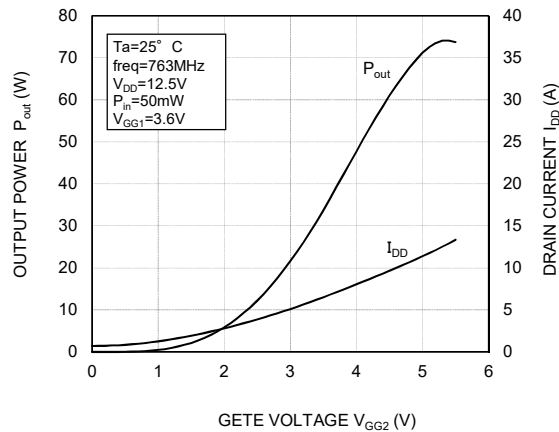
OUTPUT POWER, POWER GAIN and DRAIN CURRENT versus INPUT POWER



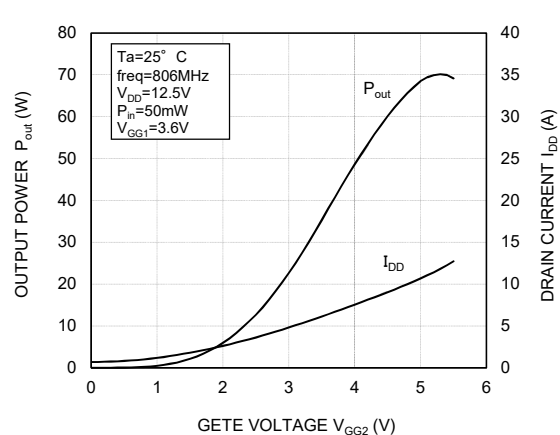
OUTPUT POWER, TOTAL EFFICIENCY and DRAIN CURRENT versus INPUT POWER



OUTPUT POWER and DRAIN CURRENT versus GATE VOLTAGE 2



OUTPUT POWER and DRAIN CURRENT versus GATE VOLTAGE 2

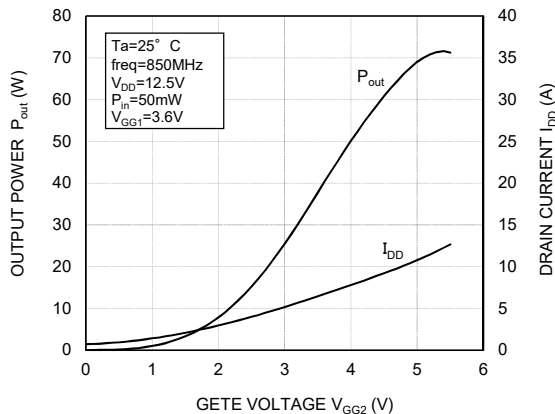


# RA50H7687M1

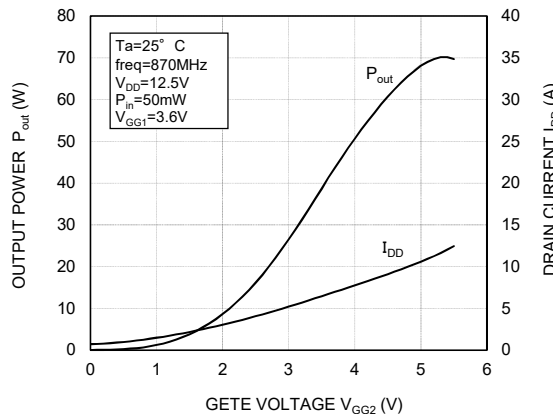
RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

TYPICAL PERFORMANCE (Tcase=+25°C, Zg=Zl=50Ω, unless otherwise specified)

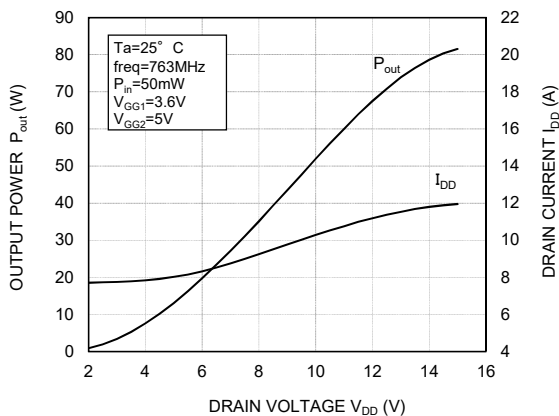
OUTPUT POWER and DRAIN CURRENT  
versus GATE VOLTAGE 2



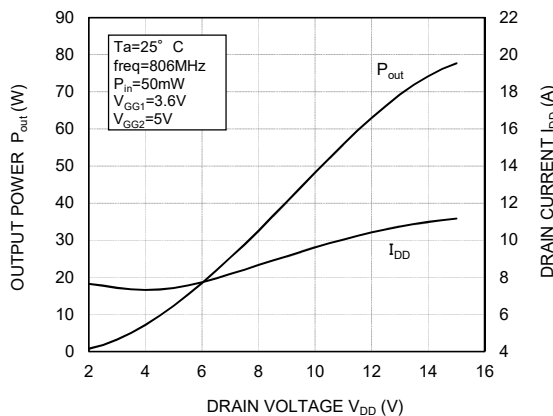
OUTPUT POWER and DRAIN CURRENT  
versus GATE VOLTAGE 2



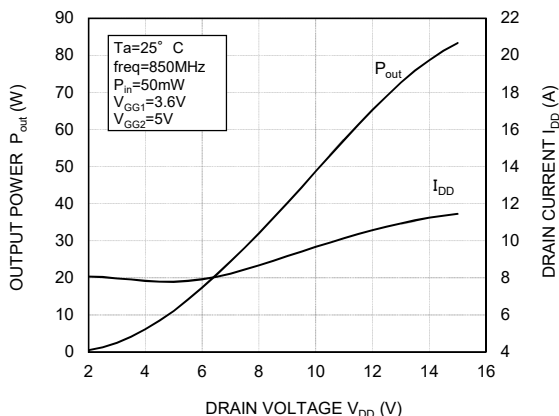
OUTPUT POWER and DRAIN CURRENT  
versus DRAIN VOLTAGE



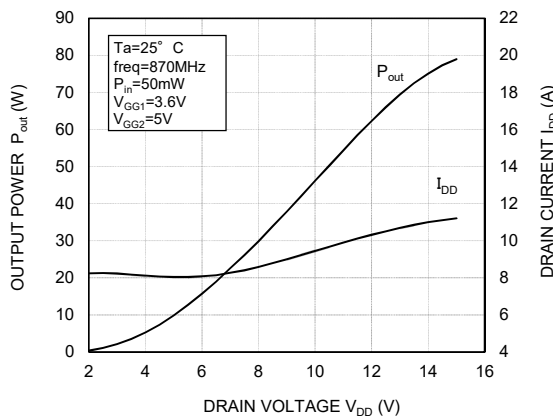
OUTPUT POWER and DRAIN CURRENT  
versus DRAIN VOLTAGE



OUTPUT POWER and DRAIN CURRENT  
versus DRAIN VOLTAGE



OUTPUT POWER and DRAIN CURRENT  
versus DRAIN VOLTAGE

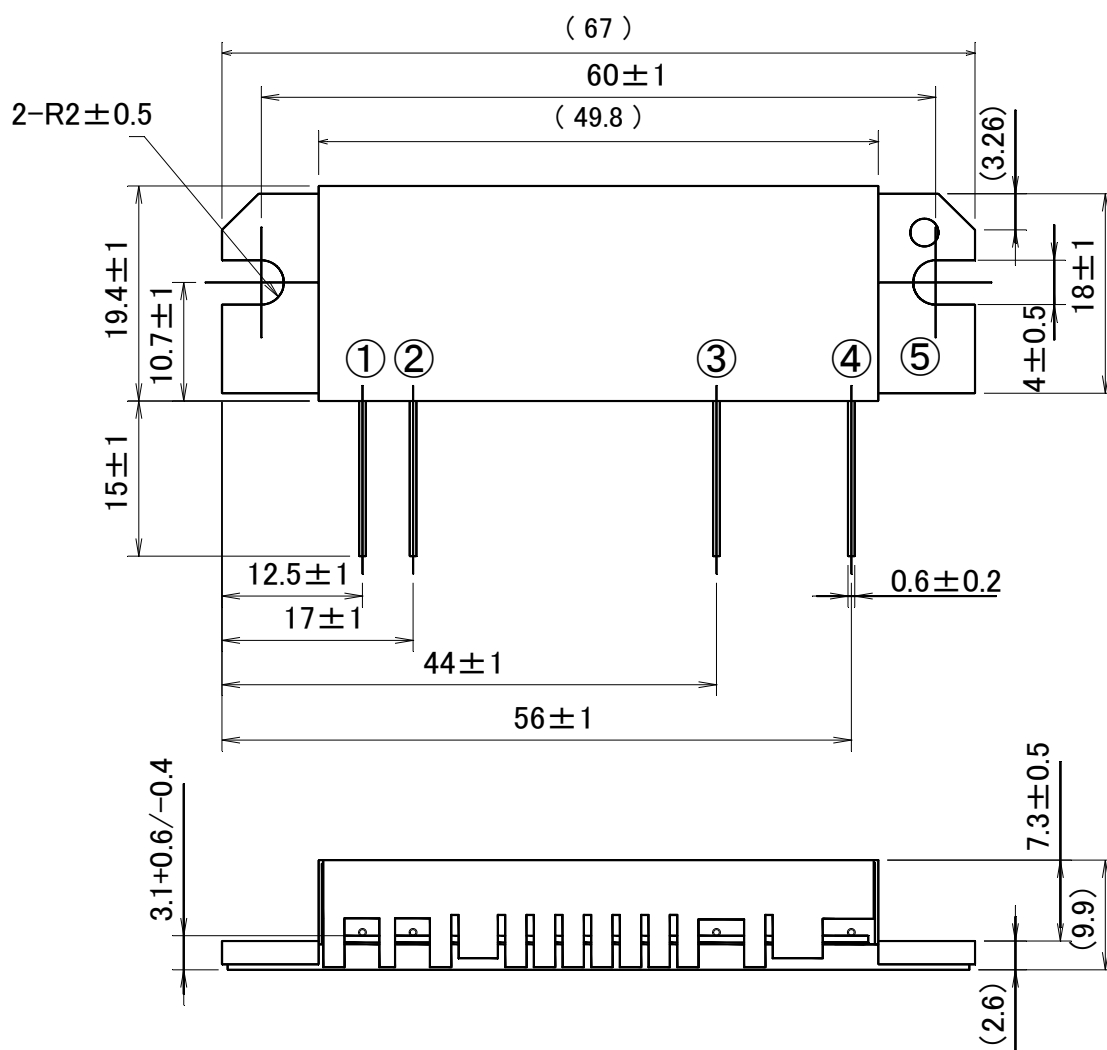


# RA50H7687M1

RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

TYPICAL PERFORMANCE (Tcase=+25°C, Zg=Zl=50Ω, unless otherwise specified)

## OUTLINE DRAWING (mm)

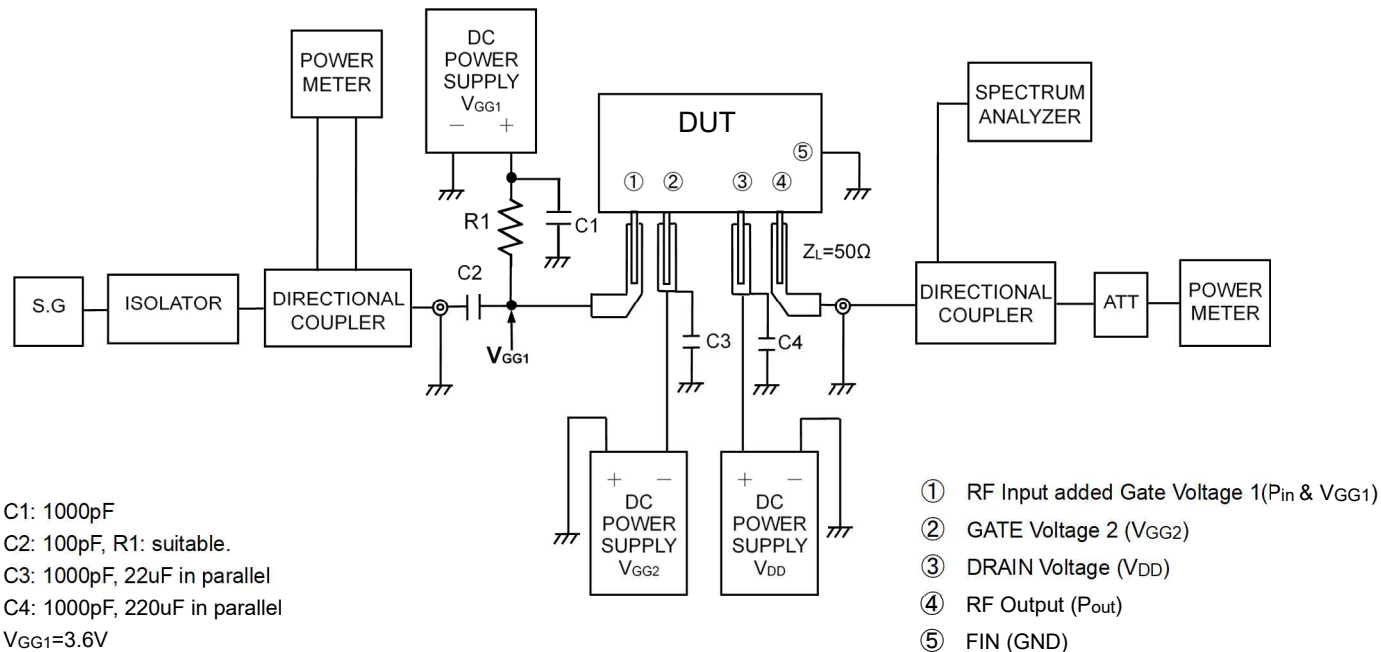


- ① RF Input added Gate Voltage 1(Pin & VGG1)
- ② GATE Voltage 2 (VGG2)
- ③ DRAIN Voltage (VDD)
- ④ RF Output (Pout)
- ⑤ FIN (GND)

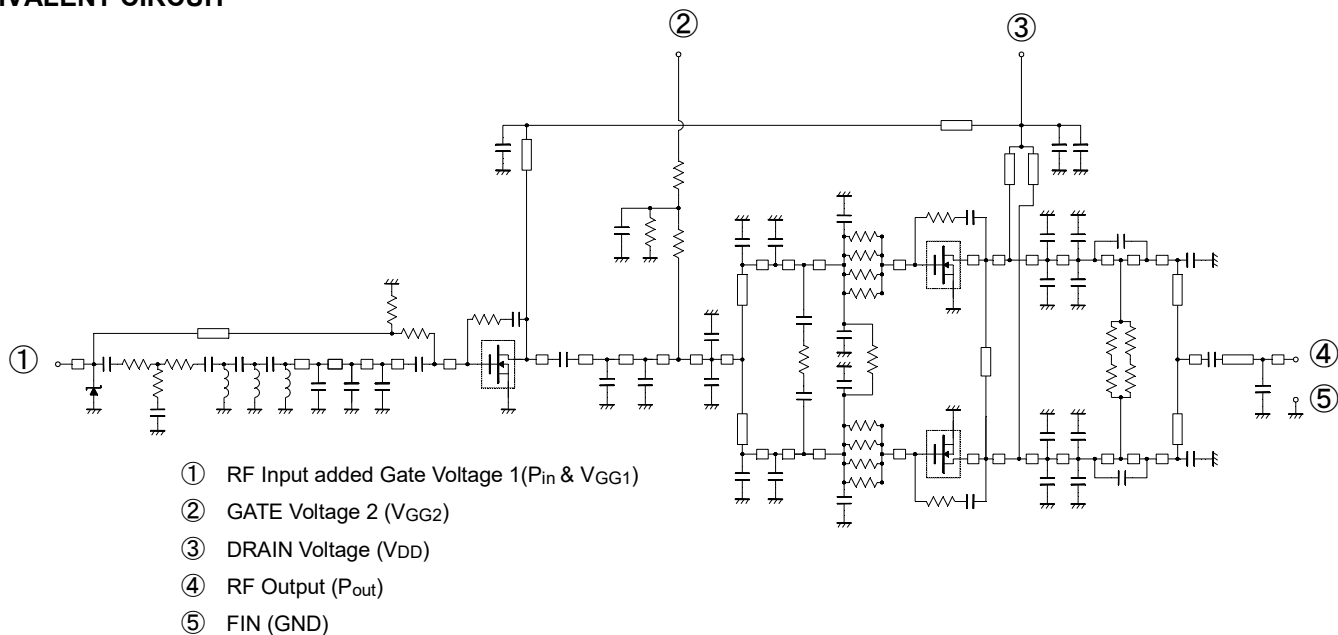
# RA50H7687M1

RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

## TEST BLOCK DIAGRAM



## EQUIVALENT CIRCUIT



NOTE: Resistance between Gate Voltage 1, where RF is input, and ground equals to 15k ohm.

External resistance connected to V<sub>GG1</sub>; impedance between P<sub>in</sub>&V<sub>GG1</sub> and ground needs to make high impedance that doesn't prevent RF characteristic on this module.

# RA50H7687M1

RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

## RECOMMENDATIONS and APPLICATION INFORMATION:

### Construction:

This module consists of a glass-epoxy substrate soldered onto a copper flange. For mechanical protection, a metal cap is attached (which makes the improvement of RF radiation easy). The MOSFET transistor chips are die bonded onto metal, wire bonded to the substrate, and coated with resin. Lines on the substrate (eventually inductors), chip capacitors, and resistors form the bias and matching circuits. Wire leads soldered onto the glass-epoxy substrate provide the DC and RF connection.

Following conditions must be avoided:

- Bending forces on the glass-epoxy substrate (for example, by driving screws or from fast thermal changes)
- Mechanical stress on the wire leads (for example, by first soldering then driving screws or by thermal expansion)
- Defluxing solvents reacting with the resin coating on the MOSFET chips (for example, Trichloroethylene)
- ESD, surge, overvoltage in combination with load VSWR, and oscillation

### ESD:

This MOSFET module is sensitive to ESD voltages down to 1000V. Appropriate ESD precautions are required.

### Mounting:

A thermal compound between module and heat sink is recommended for low thermal contact resistance. The module must first be screwed to the heat sink, then the leads can be soldered to the printed circuit board. M3 screws are recommended with a tightening torque of 4.0 to 6.0 kgf-cm.

### Soldering and Defluxing:

This module is designed for manual soldering.

The leads must be soldered after the module is screwed onto the heat sink.

The temperature of the lead (terminal) soldering should be lower than 350°C and shorter than 3 second.

Ethyl Alcohol is recommend for removing flux. Trichloroethylene solvents must not be used (they may cause bubbles in the coating of the transistor chips which can lift off the bond wires).

### Thermal Design of the Heat Sink:

At  $P_{out}=50W$ ,  $V_{DD}=12.5V$  and  $P_{in}=50mW$  each stage transistor operating conditions are:

Stage	$P_{in}$ (W)	$P_{out}$ (W)	$R_{th(ch-case)}$ (°C/W)	$I_{DD} @ \eta_T=40\%$ (A)	$V_{DD}$ (V)
1 <sup>st</sup>	0.05	4.0	2.5	0.8	12.5
2 <sup>nd</sup>	4.0	50	0.57	9.2	

The channel temperatures of each stage transistor  $T_{ch} = T_{case} + (V_{DD} \times I_{DD} - P_{out} + P_{in}) \times R_{th(ch-case)}$  are:

$$T_{ch1} = T_{case} + (12.5V \times 0.8A - 4.0W + 0.05W) \times 2.5^{\circ}C/W = T_{case} + 15.1^{\circ}C$$

$$T_{ch2} = T_{case} + (12.5V \times 9.2A - 50.0W + 4.0W) \times 0.57^{\circ}C/W = T_{case} + 39.3^{\circ}C$$

For long-term reliability, it is best to keep the module case temperature ( $T_{case}$ ) below 90°C. For an ambient temperature  $T_{air}=60^{\circ}C$  and  $P_{out}=50W$ , the required thermal resistance  $R_{th(case-air)} = (T_{case} - T_{air}) / ((P_{out} / \eta_T) - P_{out} + P_{in})$  of the heat sink, including the contact resistance, is:

$$R_{th(case-air)} = (90^{\circ}C - 60^{\circ}C) / (50W/40\% - 50W + 0.05W) = 0.4^{\circ}C/W$$

When mounting the module with the thermal resistance of 0.4 °C/W, the channel temperature of each stage transistor is:

$$T_{ch1} = T_{air} + 45.1^{\circ}C$$

$$T_{ch2} = T_{air} + 69.3^{\circ}C$$

The 175°C maximum rating for the channel temperature ensures application under derated conditions.

# RA50H7687M1

RoHS Compliance, 763-870MHz 50W 12.5V, 2 Stage Amp. For MOBILE Radio

## **Keep safety first in your circuit designs!**

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

## **Notes regarding these materials**

- These materials are intended as a reference to assist our customers in the selection of the Mitsubishi Electric Semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.
- Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for the latest product information before purchasing a product listed herein.  
The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.  
Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Electric Semiconductor home page (<http://www.MitsubishiElectric.com/semiconductor/>).
- When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials.
- If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.  
Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for further details on these materials or the products contained therein.

G2K-Si-221012-1

© Mitsubishi Electric Corporation